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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Application Serial No	10/705,685
Confirmation No	
Filing Date	November 10, 2003
Inventors	John R. Tuttle
Assignee	Micron Technology, Inc.
Group Art Unit	
Examiner	
Customer No	021567
Attorney Docket No	MI40-382
Title: Miniature Radio Frequency Transceiver	

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

References – See Attached Form PTO-1449

The attached form PTO-1449 is submitted in compliance with 37 CFR §1.56. No admission is made regarding whether all the submitted references are prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Datad:

Bv

Deepak Malhotra Reg. No. 33,560

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U.S. DEPARTMENT OF COMMERCE

WATER T AND TRADEMARK OFFICE

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ATTY. DOCKET NO. SERIAL NO. 10/705,685

APPLICANT
JOHN R. TUTTLE

FILING DATE
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	AH	DE 41 20 265 A1	6/1991	Germany (Mitsubishi) See US 5,274,221 (prev. cited)	C	G06K	7/01	Abs	110	
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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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Form PTO-1449 ATTY. DOCKET NO. SERIAL NO. MI40-382 10/705,685 TENT AND TRADEMARK OFFICE **APPLICANT** JOHN R. TUTTLE SEP 19 2005 LIST OF ART CITED BY APPLICANT FILING DATE **GROUP** (Use several sheets if necessary) NOV. 10, 2003 2632 TRADE U.S. PATENT DOCUMENTS Document Date Class Examiner Subclass Filing Date Name Initial Number If Appropriate AA AB AC AD AE AF AG FOREIGN PATENT DOCUMENTS Document Date Country Class Subclass Translation Number Yes No AH 7/1990 015/10 JP 2-179794 Japan (Sony Corp.) B42D Abs ΑJ JP 3-224799 Japan (Sony Corp.) 10/1991 B42D 015/10 Abs ΑK JP 4-359183 11/1992 Japan (Nippondenso Co. Ltd) **G01S** 013/80 Abs AL OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.) AM AN AO AP **EXAMINER** DATE CONSIDERED *EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.